Reissue Application no. 10/062,3

May 9, 2002

TO COMMISSION Washington

Commissioner of Patents and Trademarks Washington, D.C. 20231

FROM:

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SUBJECT:

Reissue Application of:

Patent #: 6,6

6,019,906

Issue Date: Inventor: Feb. 1, 2000 Syun-Ming Jang, Ming-Hsin Huang

Title:

Hard Masking Method for Forming Patterned Oxygen

Containing Plasma Etchable Layer

Reissue Serial Number:

10/062,314

Reissue File Date:

Feb. 1, 2002

MAY 23 2002 10 1700

PRELIMINARY AMENDMENT

This regards the Reissue Application of the above identified patent. Please amend the above-identified patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231 on May 9,2002

Signature

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Date:

5/9/02